NEW PRODUCT



Conforms to CFast[™] Specification Rev.1.0.

JST

• Card assembly method

Features

Two types of Snap-in/Ultra Sonic Welding are prepared.

Ground connection

The connector has GND spring which is connecting with No.PC16 to enable secure connection between metal cover and PCB.

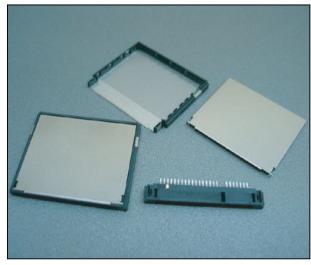
• Transmission characteristic

This connector considers transmission characteristic up to 3Gbps data transmission.

• Ejector with a structure of preventing card from jumping out.

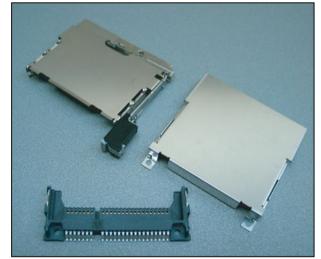
Slide lock to prevent card from jumping out is added to the ejector.

★ Frame Kit for CFast [™] Type I Card



- Card Connector: CFF- CC24S-1521-GB25T (LF)(SN) * Embossed-taping product
- Top Cover : Snap in type ; CFF-FT1S-11FM Weld type ; CFF-FT1U-11FM
- Bottom Cover : CFF-FBU-12FM
- Conforms to CFast[™] Specification Revision1.0
- Compliance with RoHS

★Host Connector for CFast[™] Type I · II Card



- Card Connector : CFF-HC24S-S352-N120T (LF)(SN) * Embossed-taping product
- Hold Cover : CFF-NE2-NS1B
- Ejector : CFF-EP2R-NS11B(LF)(SN)
- Conforms to CFast[™] Specification Revision1.0
- Compliance with RoHS
- * Please contact JST for details.



Specifications

- Operating temperature
 - : -40°C to +85°C (including temperature rise in applying electrical current)
- Contact resistance
 - : Initial value/30m Ω max.
 - : After environmental testing/15 m $\Omega\,$ max. (Variation amount from initial value)
- Withstanding voltage : AC 500 V/1 minute
- Insulation resistance
 - : 1,000MΩ min, DC500V
- Mating/Unmating life : 10,000 cycles
- No.of Circuits : 24 circuit